

INA121

FET-Input, Low Power INSTRUMENTATION AMPLIFIER

FEATURES

- **LOW BIAS CURRENT:** $\pm 4\text{pA}$
- **LOW QUIESCENT CURRENT:** $\pm 450\mu\text{A}$
- **LOW INPUT OFFSET VOLTAGE:** $\pm 200\mu\text{V}$
- **LOW INPUT OFFSET DRIFT:** $\pm 2\mu\text{V}/^\circ\text{C}$
- **LOW INPUT NOISE:**
 $20\text{nV}/\sqrt{\text{Hz}}$ at $f = 1\text{kHz}$ ($G = 100$)
- **HIGH CMR:** 106dB
- **WIDE SUPPLY RANGE:** $\pm 2.25\text{V}$ to $\pm 18\text{V}$
- **LOW NONLINEARITY ERROR:** 0.001% max
- **INPUT PROTECTION TO $\pm 40\text{V}$**
- **8-PIN DIP AND SO-8 SURFACE MOUNT**

APPLICATIONS

- **LOW-LEVEL TRANSDUCER AMPLIFIERS**
Bridge, RTD, Thermocouple
- **PHYSIOLOGICAL AMPLIFIERS**
ECG, EEG, EMG, Respiratory
- **HIGH IMPEDANCE TRANSDUCERS**
- **CAPACITIVE SENSORS**
- **MULTI-CHANNEL DATA ACQUISITION**
- **PORTABLE, BATTERY OPERATED SYSTEMS**
- **GENERAL PURPOSE INSTRUMENTATION**

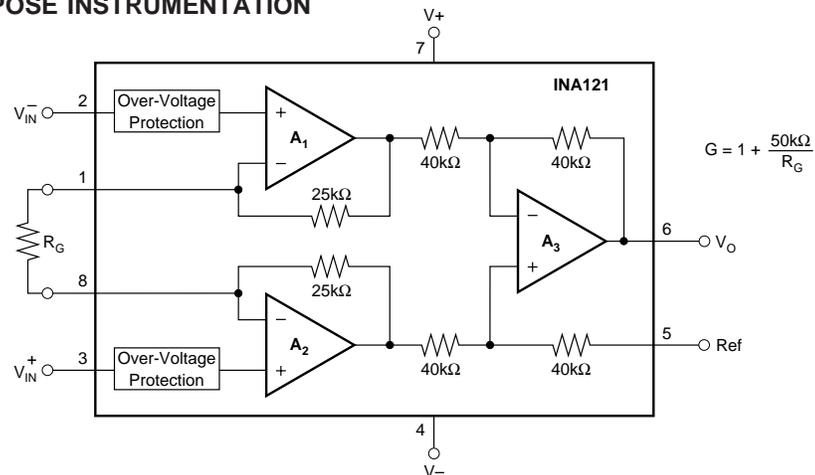
DESCRIPTION

The INA121 is a FET-input, low power instrumentation amplifier offering excellent accuracy. Its versatile three-op amp design and very small size make it ideal for a variety of general purpose applications. Low bias current ($\pm 4\text{pA}$) allows use with high impedance sources.

Gain can be set from 1V to 10,000V/V with a single external resistor. Internal input protection can withstand up to $\pm 40\text{V}$ without damage.

The INA121 is laser-trimmed for very low offset voltage ($\pm 200\mu\text{V}$), low offset drift ($\pm 2\mu\text{V}/^\circ\text{C}$), and high common-mode rejection (106dB at $G = 100$). It operates on power supplies as low as $\pm 2.25\text{V}$ ($+4.5\text{V}$), allowing use in battery operated and single 5V systems. Quiescent current is only $450\mu\text{A}$.

Package options include 8-pin plastic DIP and SO-8 surface mount. All are specified for the -40°C to $+85^\circ\text{C}$ industrial temperature range.



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Internet: <http://www.burr-brown.com/> • FAXLine: (800) 548-6133 (US/Canada Only) • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

SPECIFICATIONS: $V_S = \pm 15V$

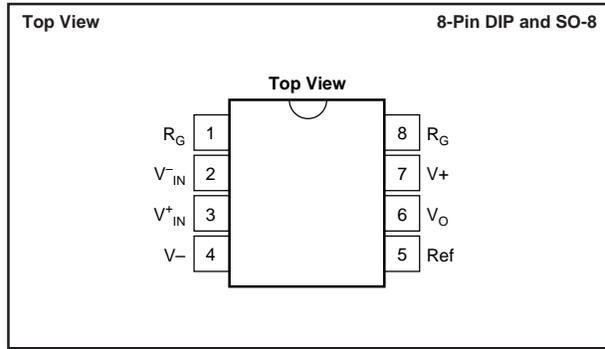
At $T_A = +25^\circ C$, $V_S = \pm 15V$, $R_L = 10k\Omega$, and I_A reference = $0V$, unless otherwise noted.

| PARAMETER | CONDITIONS | INA121P, U | | | INA121PA, UA | | | UNITS | |
|---------------------------------------|--------------------------------|--------------|-----------------------------|------------------------|--------------|---------------------|-----------------------|-----------------------------|----|
| | | MIN | TYP | MAX | MIN | TYP | MAX | | |
| INPUT | | | | | | | | | |
| Offset Voltage, RTI vs Temperature | $V_S = \pm 2.25V$ to $\pm 18V$ | | $\pm 200 \pm 200/G$ | $\pm 500 \pm 500/G$ | | $\pm 300 \pm 200/G$ | $\pm 1000 \pm 1000/G$ | μV $\mu V/^\circ C$ | |
| vs Power Supply | | | $\pm 2 \pm 2/G$ | $\pm 5 \pm 20/G$ | | * | $\pm 15 \pm 20/G$ | $\mu V/V$ | |
| Long-Term Stability | | | $\pm 5 \pm 20/G$ | $\pm 50 \pm 150/G$ | | * | * | $\mu V/mo$ | |
| Impedance, Differential | $V_O = 0V$ | | ± 0.5 | | | * | * | $\Omega \parallel pF$ | |
| Common-Mode | | | $10^{12} \parallel 1$ | $10^{12} \parallel 12$ | | * | * | $\Omega \parallel pF$ | |
| Input Voltage Range | $V_{CM} = -12.5V$ to $13.5V$ | | See Text and Typical Curves | | | * | * | V | |
| Safe Input Voltage | | | | ± 40 | | * | * | | |
| Common-Mode Rejection | | $G = 1$ | 78 | 86 | | 72 | * | | dB |
| | | $G = 10$ | 91 | 100 | | 85 | * | | dB |
| | $G = 100$ | 96 | 106 | | 90 | * | | dB | |
| | $G = 1000$ | | 106 | | | * | | dB | |
| BIAS CURRENT | $V_{CM} = 0V$ | | ± 4 | ± 50 | | * | * | pA | |
| vs Temperature | | | See Typical Curve | | | * | * | | |
| Offset Current | | | ± 0.5 | | | * | * | pA | |
| vs Temperature | | | See Typical Curve | | | * | * | | |
| NOISE, RTI | $R_S = 0\Omega$ | | | | | | | | |
| Voltage Noise: $f = 10Hz$ | $G = 100$ | | 30 | | | * | | nV/\sqrt{Hz} | |
| $f = 100Hz$ | $G = 100$ | | 21 | | | * | | nV/\sqrt{Hz} | |
| $f = 1kHz$ | $G = 100$ | | 20 | | | * | | nV/\sqrt{Hz} | |
| $f = 0.1Hz$ to $10Hz$ | $G = 100$ | | 1 | | | * | | $\mu Vp-p$ | |
| Current Noise: $f = 1kHz$ | | | 1 | | | * | | fA/\sqrt{Hz} | |
| GAIN | | | | | | | | | |
| Gain Equation | $V_O = -14V$ to $13.5V$ | 1 | $1 + (50k\Omega/R_G)$ | | | * | * | V/V | |
| Range of Gain | | | | 10,000 | | * | * | V/V | |
| Gain Error | | $G = 1$ | | ± 0.01 | ± 0.05 | | * | ± 0.1 | % |
| | | $G = 10$ | | ± 0.03 | ± 0.4 | | * | ± 0.5 | % |
| | $G = 100$ | | ± 0.05 | ± 0.5 | | * | ± 0.7 | % | |
| | $G = 1000$ | | ± 0.5 | | | * | * | % | |
| Gain vs Temperature ⁽¹⁾ | $G = 1$ | | ± 1 | ± 10 | | * | * | ppm/ $^\circ C$ | |
| | $G > 1$ | | ± 25 | ± 100 | | * | * | ppm/ $^\circ C$ | |
| Nonlinearity | $V_O = -14V$ to $13.5V$ | | | | | * | | % of FSR | |
| | $G = 1$ | | ± 0.0002 | ± 0.001 | | * | ± 0.002 | % of FSR | |
| | $G = 10$ | | ± 0.0015 | ± 0.005 | | * | ± 0.008 | % of FSR | |
| | $G = 100$ | | ± 0.0015 | ± 0.005 | | * | ± 0.008 | % of FSR | |
| | $G = 1000$ | | ± 0.002 | | | * | | % of FSR | |
| OUTPUT | | | | | | | | | |
| Voltage: Positive | $R_L = 100k\Omega$ | | $(V+) - 0.9$ | | | * | | V | |
| Negative | $R_L = 100k\Omega$ | | $(V-) + 0.15$ | | | * | | V | |
| Positive | $R_L = 10k\Omega$ | $(V+) - 1.5$ | $(V+) - 0.9$ | | * | * | | V | |
| Negative | $R_L = 10k\Omega$ | $(V-) + 1$ | $(V-) + 0.25$ | | * | * | | V | |
| Capacitance Load Drive | | | 1000 | | | * | | pF | |
| Short-Circuit Current | | | ± 14 | | | * | | mA | |
| FREQUENCY RESPONSE | | | | | | | | | |
| Bandwidth, $-3dB$ | $G = 1$ | | 600 | | | * | | kHz | |
| | $G = 10$ | | 300 | | | * | | kHz | |
| | $G = 100$ | | 50 | | | * | | kHz | |
| | $G = 1000$ | | 5 | | | * | | kHz | |
| Slew Rate | $V_O = \pm 10V$, $G \leq 10$ | | 0.7 | | | * | | V/ μs | |
| Settling Time, 0.01% | $G = 1$ to 10 | | 20 | | | * | | μs | |
| | $G = 100$ | | 35 | | | * | | μs | |
| | $G = 1000$ | | 260 | | | * | | μs | |
| Overload Recovery | 50% Input Overload | | 5 | | | * | | μs | |
| POWER SUPPLY | | | | | | | | | |
| Voltage Range | | ± 2.25 | ± 15 | ± 18 | * | * | * | V | |
| Quiescent Current | $I_O = 0V$ | | ± 450 | ± 525 | | * | * | μA | |
| TEMPERATURE RANGE | | | | | | | | | |
| Specification | | -40 | | 85 | * | | * | $^\circ C$ | |
| Operating | | -55 | | 125 | * | | * | $^\circ C$ | |
| Storage | | -55 | | 125 | * | | * | $^\circ C$ | |
| Thermal Resistance, θ_{JA} | | | | | | | | | |
| 8-Lead DIP | | | 100 | | | * | | $^\circ C/W$ | |
| SO-8 Surface Mount | | | 150 | | | * | | $^\circ C/W$ | |

* Specification same as INA121P, U.

NOTE: (1) Temperature coefficient of the "Internal Resistor" in the gain equation. Does not include TCR of gain-setting resistor, R_G .

PIN CONFIGURATION



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

| | |
|---|-----------------------------------|
| Supply Voltage | $\pm 18V$ |
| Analog Input Voltage Range | $\pm 40V$ |
| Output Short-Circuit (to ground) | Continuous |
| Operating Temperature | $-55^{\circ}C$ to $+125^{\circ}C$ |
| Storage Temperature | $-55^{\circ}C$ to $+125^{\circ}C$ |
| Junction Temperature | $+150^{\circ}C$ |
| Lead Temperature (soldering, 10s) | $+300^{\circ}C$ |

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

PACKAGE/ORDERING INFORMATION

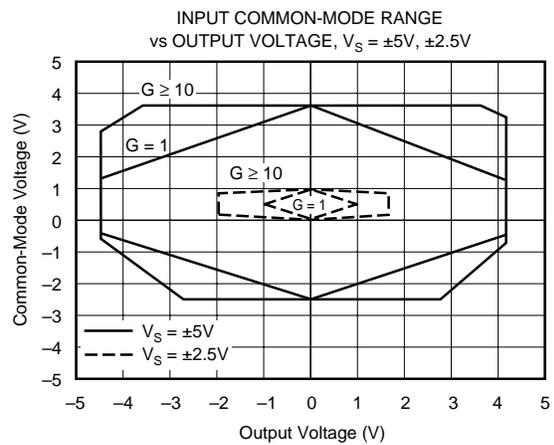
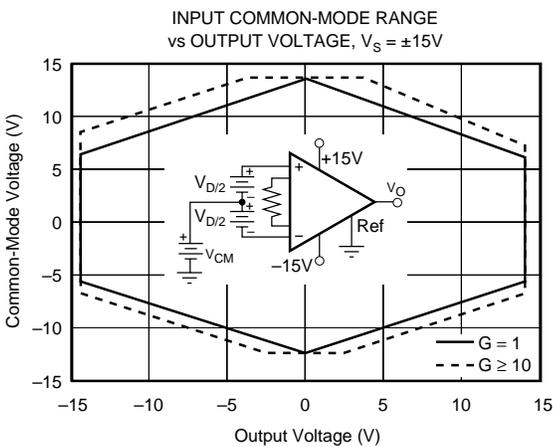
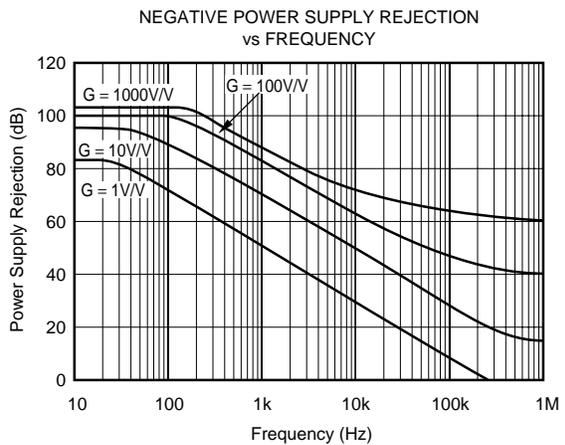
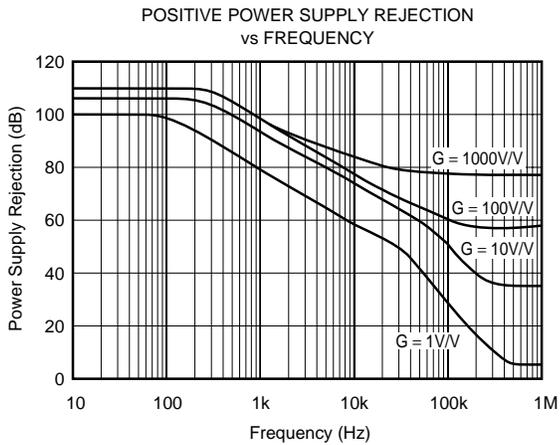
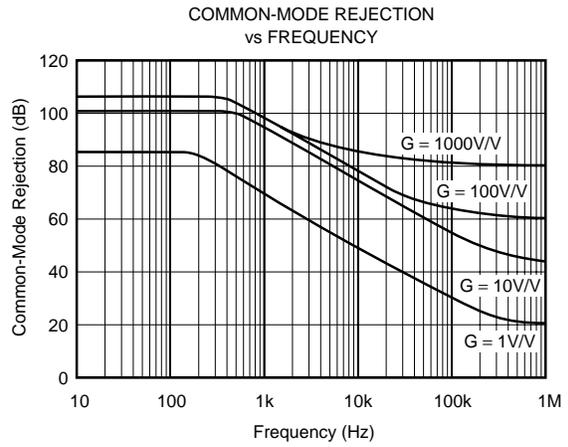
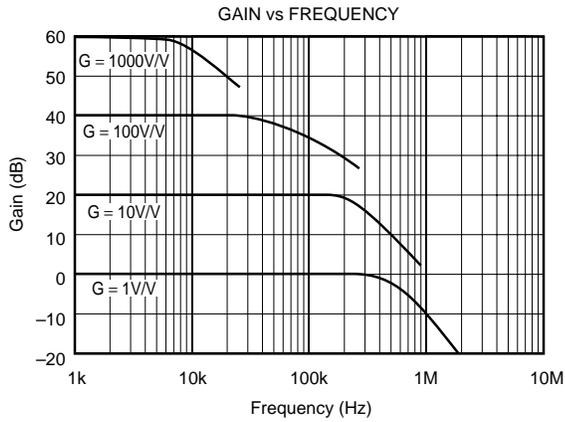
| PRODUCT | PACKAGE | PACKAGE DRAWING NUMBER(1) | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER(2) | TRANSPORT MEDIA |
|----------|--------------------|---------------------------|----------------------------------|-----------------|--------------------|-----------------|
| Single | | | | | | |
| INA121P | 8-Pin DIP | 006 | $-40^{\circ}C$ to $+85^{\circ}C$ | INA121P | INA121P | Rails |
| INA121PA | 8-Pin DIP | 006 | $-40^{\circ}C$ to $+85^{\circ}C$ | INA121PA | INA121PA | Rails |
| INA121U | SO-8 Surface-Mount | 182 | $-40^{\circ}C$ to $+85^{\circ}C$ | INA121U | INA121U | Rails |
| " | " | " | " | " | INA121U/2K5 | Tape and Reel |
| INA121UA | SO-8 Surface-Mount | 182 | $-40^{\circ}C$ to $+85^{\circ}C$ | INA121UA | INA121UA | Rails |
| " | " | " | " | " | INA121UA/2K5 | Tape and Reel |

NOTES: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book. (2) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K5 indicates 2500 devices per reel). Ordering 2500 pieces of "INA121U/2K5" will get a single 2500-piece Tape and Reel. For detailed Tape and Reel mechanical information, refer to Appendix B of Burr-Brown IC Data Book.

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.

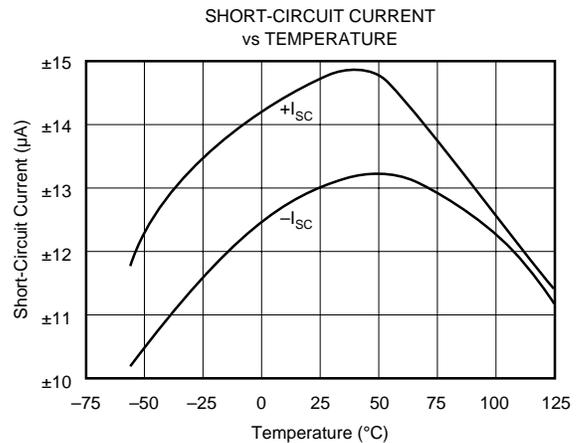
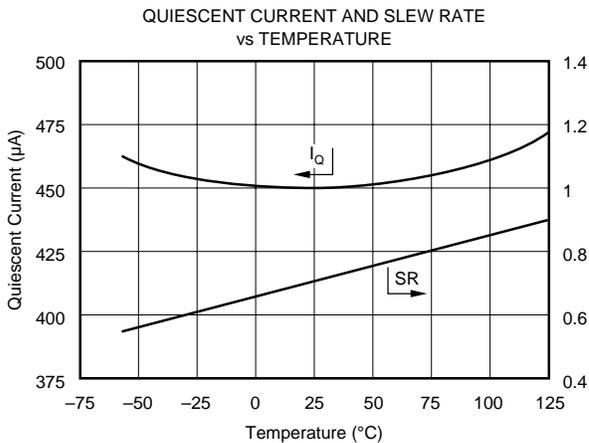
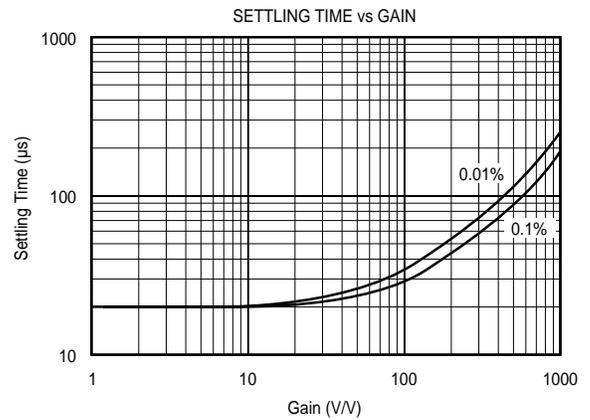
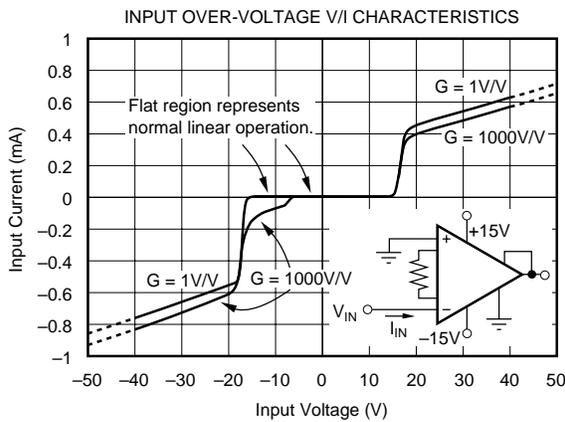
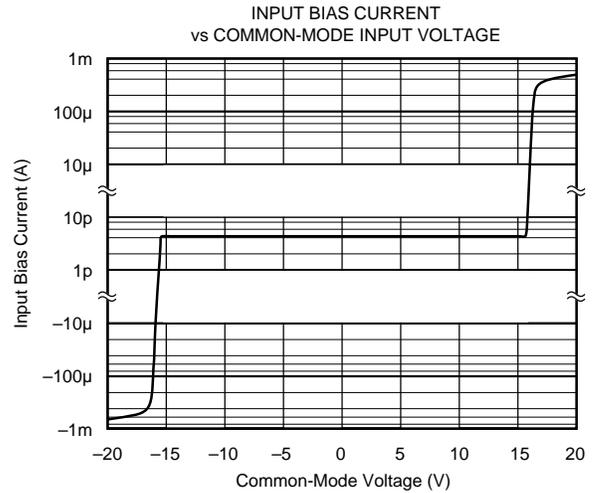
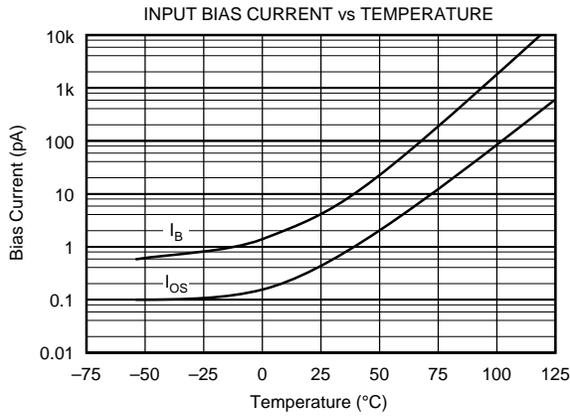
TYPICAL PERFORMANCE CURVES

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



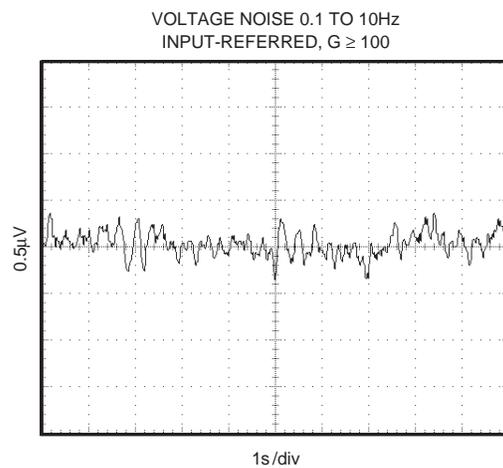
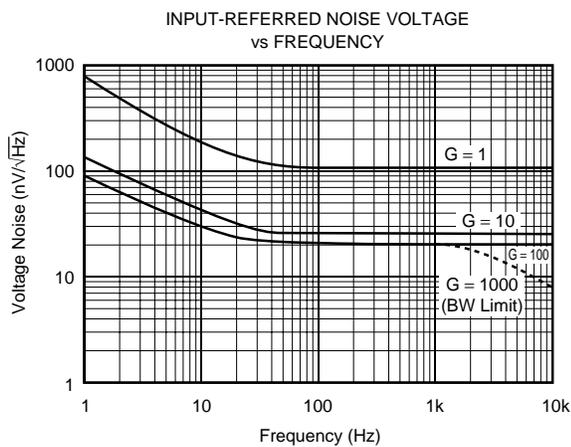
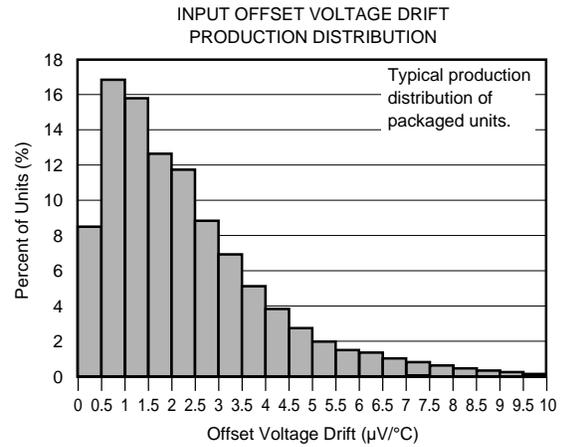
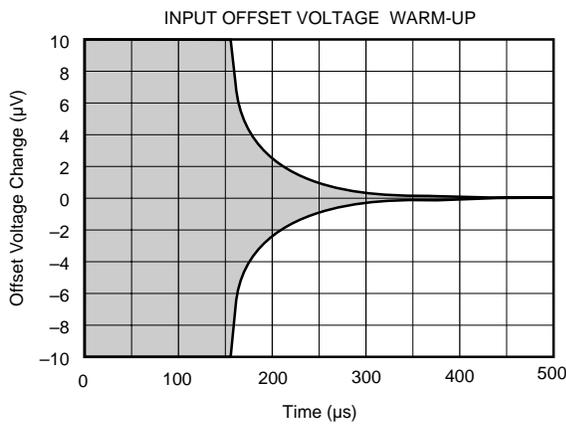
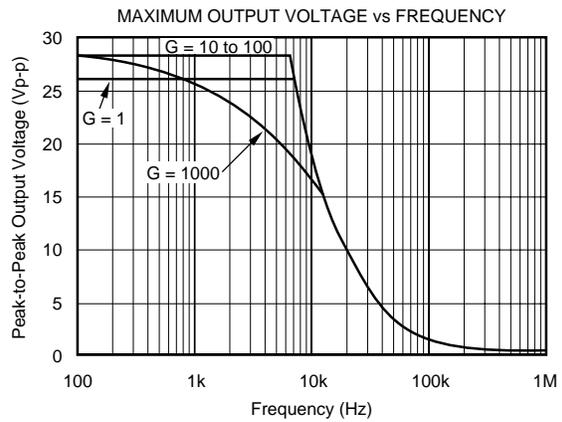
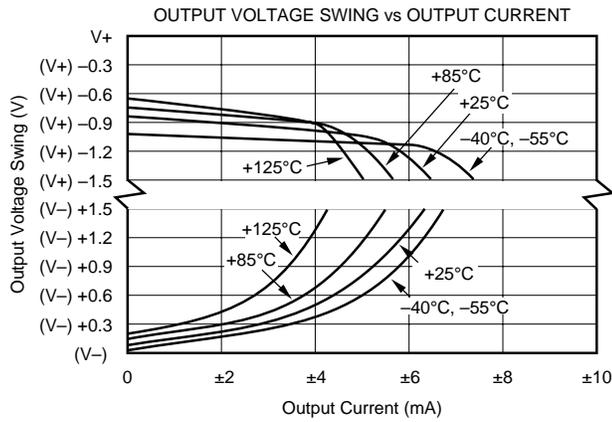
TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



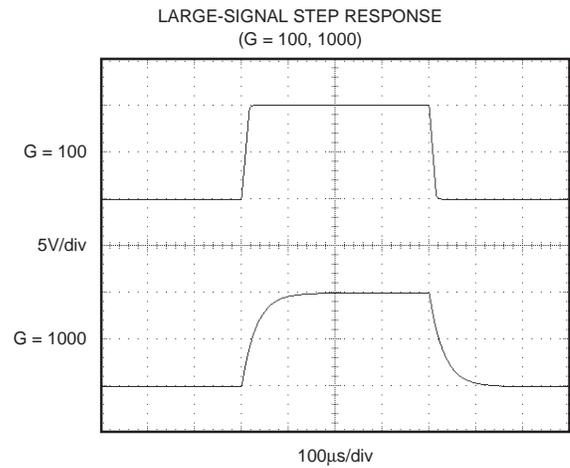
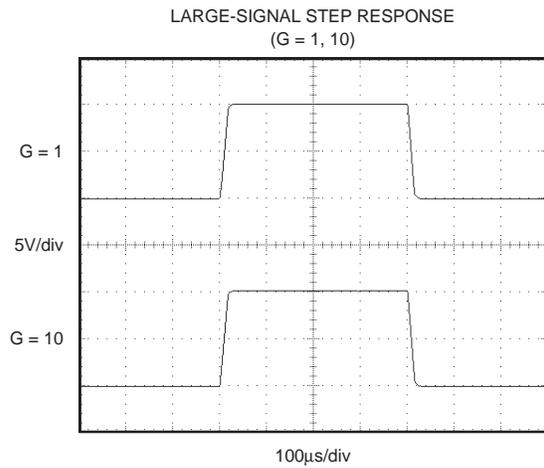
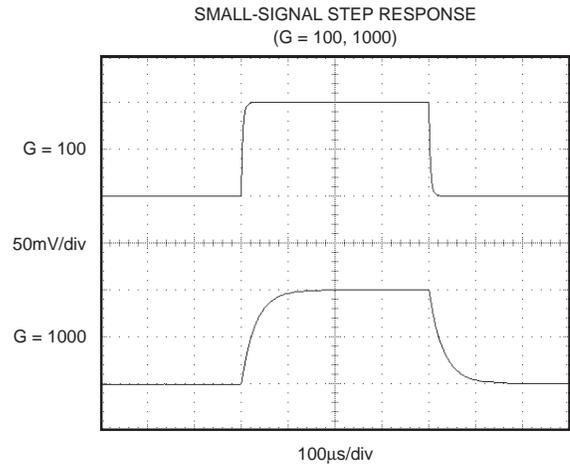
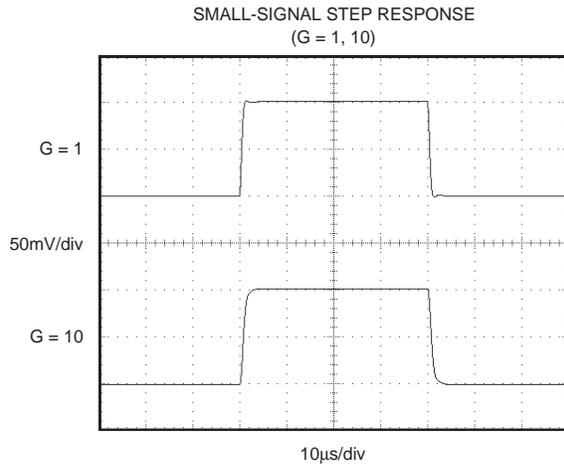
TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, unless otherwise noted.



APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the INA121. Applications with noisy or high impedance power supplies may require decoupling capacitors close to the device pins as shown.

The output is referred to the output reference (Ref) terminal which is normally grounded. This must be a low-impedance connection to assure good common-mode rejection. A resistance of 8Ω in series with the Ref pin will cause a typical device to degrade to approximately 80dB CMR ($G = 1$).

SETTING THE GAIN

Gain of the INA121 is set by connecting a single external resistor, R_G , connected between pins 1 and 8:

$$G = 1 + \frac{50k\Omega}{R_G} \tag{1}$$

Commonly used gains and resistor values are shown in Figure 1.

The 50kΩ term in Equation 1 comes from the sum of the two internal feedback resistors of A_1 and A_2 . These on-chip metal film resistors are laser trimmed to accurate absolute values. The accuracy and temperature coefficient of these resistors are included in the gain accuracy and drift specifications of the INA121.

The stability and temperature drift of the external gain setting resistor, R_G , also affects gain. R_G 's contribution to gain accuracy and drift can be directly inferred from the gain equation (1). Low resistor values required for high gain can make wiring resistance important. Sockets add to the wiring resistance which will contribute additional gain error (possibly an unstable gain error) in gains of approximately 100 or greater.

DYNAMIC PERFORMANCE

The typical performance curve "Gain vs Frequency" shows that, despite its low quiescent current, the INA121 achieves wide bandwidth, even at high gain. This is due to the current-feedback topology of the INA121. Settling time also remains excellent at high gain.

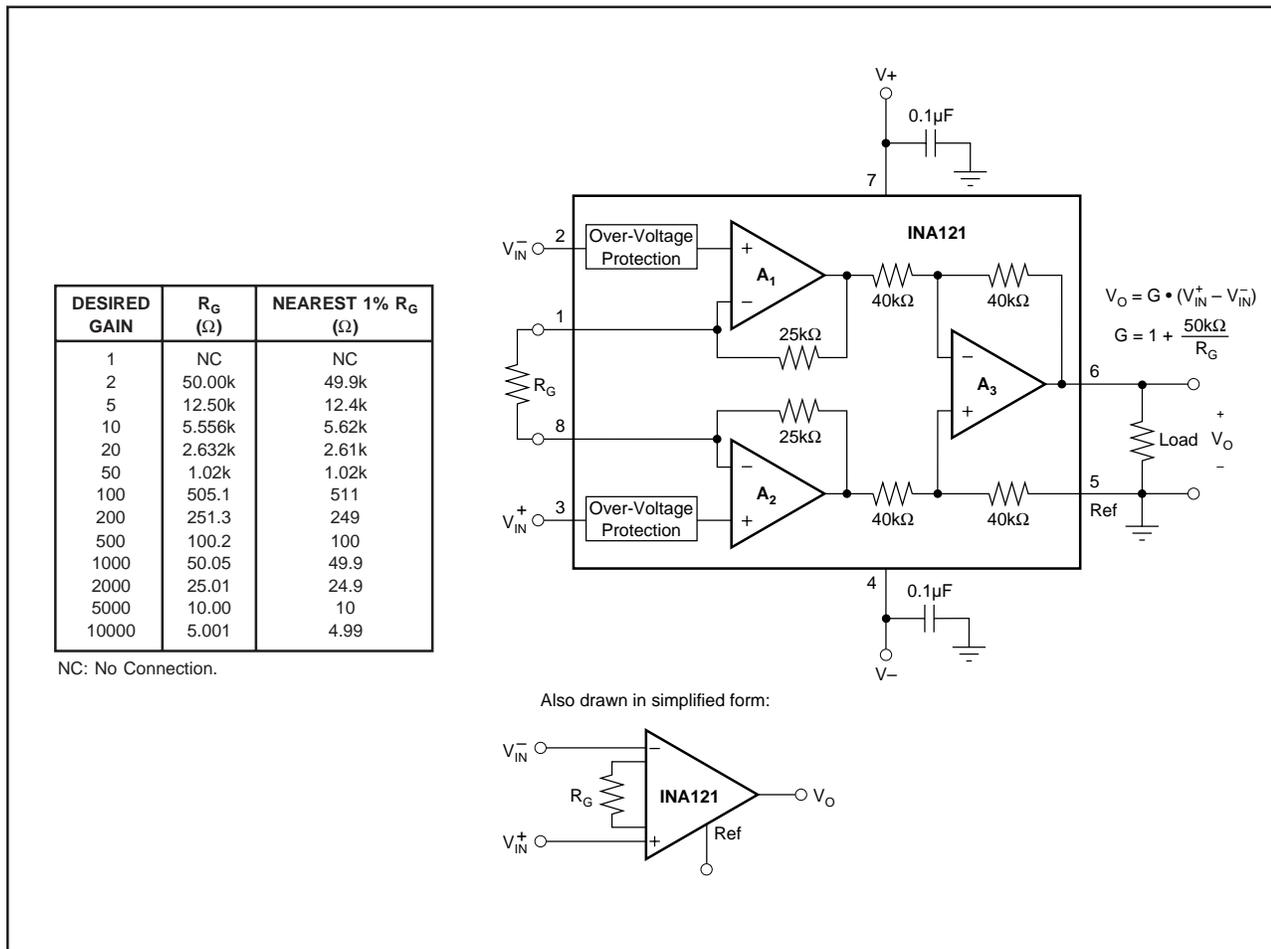


FIGURE 1. Basic Connections.

The INA121 provides excellent rejection of high frequency common-mode signals. The typical performance curve, “Common-Mode Rejection vs Frequency” shows this behavior. If the inputs are not properly balanced, however, common-mode signals can be converted to differential signals. Run the V_{IN}^+ and V_{IN}^- connections directly adjacent each other, from the source signal all the way to the input pins. If possible use a ground plane under both input traces. Avoid running other potentially noisy lines near the inputs.

NOISE AND ACCURACY PERFORMANCE

The INA121’s FET input circuitry provides low input bias current and high speed. It achieves lower noise and higher accuracy with high impedance sources. With source impedances of 2k Ω to 50k Ω the INA114, INA128, or INA129 may provide lower offset voltage and drift. For very low source impedance ($\leq 1k\Omega$), the INA103 may provide improved accuracy and lower noise. At very high source impedances ($> 1M\Omega$) the INA116 is recommended.

OFFSET TRIMMING

The INA121 is laser trimmed for low offset voltage and drift. Most applications require no external offset adjustment. Figure 2 shows an optional circuit for trimming the output offset voltage. The voltage applied to Ref terminal is summed at the output. The op amp buffer provides low impedance at the Ref terminal to preserve good common-mode rejection. Trim circuits with higher source impedance should be buffered with an op amp follower circuit to assure low impedance on the Ref pin.

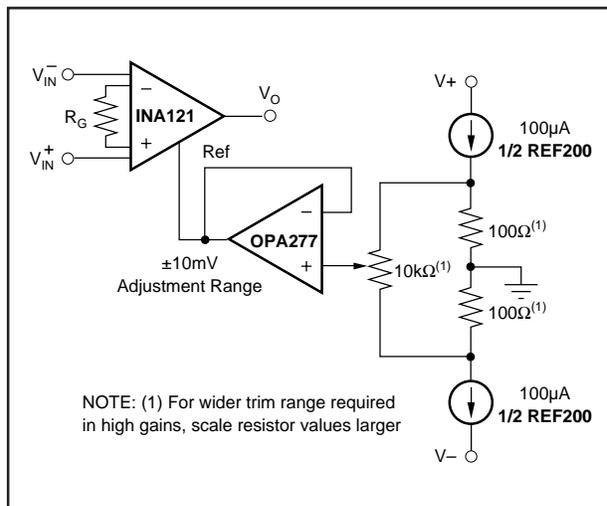


FIGURE 2. Optional Trimming of Output Offset Voltage.

INPUT BIAS CURRENT RETURN PATH

The input impedance of the INA121 is extremely high—approximately $10^{12}\Omega$. However, a path must be provided for the input bias current of both inputs. This input bias current is typically 4pA. High input impedance means that this input bias current changes very little with varying input voltage.

Input circuitry must provide a path for this input bias current if the INA121 is to operate properly. Figure 3 shows various provisions for an input bias current path. Without a bias current return path, the inputs will float to a potential which exceeds the common-mode range of the INA121 and the input amplifiers will saturate.

If the differential source resistance is low, the bias current return path can be connected to one input (see the thermocouple example in Figure 3). With higher source impedance, using two resistors provides a balanced input with possible advantages of lower input offset voltage due to bias current and better high-frequency common-mode rejection.

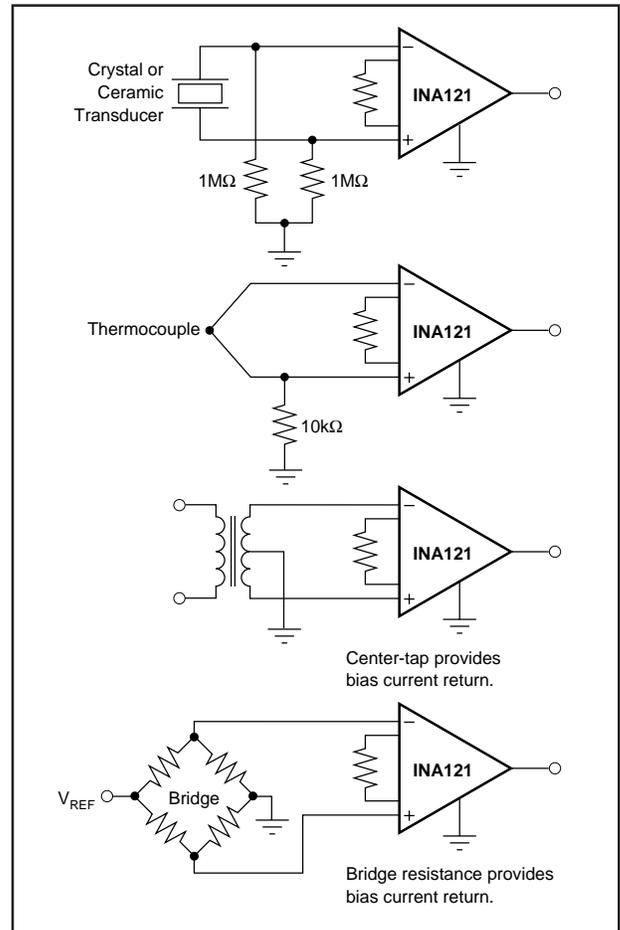


FIGURE 3. Providing an Input Common-Mode Current Path.

INPUT COMMON-MODE RANGE

The linear input voltage range of the input circuitry of the INA121 is from approximately 1.2V below the positive supply voltage to 2.1V above the negative supply. A differential input voltage causes the output voltage to increase. The linear input range, however, will be limited by the output voltage swing of amplifiers A_1 and A_2 . So the linear common-mode input range is related to the output voltage of the complete amplifier. This behavior also depends on supply voltage—see typical performance curve “Input Common-Mode Range vs Output Voltage”.

A combination of common-mode and differential input voltage can cause the output of A_1 or A_2 to saturate. Figure 4 shows the output voltage swing of A_1 and A_2 expressed in terms of a common-mode and differential input voltages. For applications where input common-mode range must be maximized, limit the output voltage swing by connecting the INA121 in a lower gain (see performance curve “Input Common-Mode Voltage Range vs Output Voltage”). If necessary, add gain after the INA121 to increase the voltage swing.

Input-overload can produce an output voltage that appears normal. For example, if an input overload condition drives both input amplifiers to their positive output swing limit, the difference voltage measured by the output amplifier will be near zero. The output of A_3 will be near 0V even though both inputs are overloaded.

LOW VOLTAGE OPERATION

The INA121 can be operated on power supplies as low as $\pm 2.25V$. Performance remains excellent with power supplies ranging from $\pm 2.25V$ to $\pm 18V$. Most parameters vary only slightly throughout this supply voltage range—see typical

performance curves. Operation at very low supply voltage requires careful attention to assure that the input voltages remain within their linear range. Voltage swing requirements of internal nodes limit the input common-mode range with low power supply voltage. Typical performance curves, “Input Common-Mode Range vs Output Voltage” show the range of linear operation for $\pm 15V$, $\pm 5V$, and $\pm 2.5V$ supplies.

INPUT FILTERING

The INA121’s FET input allows use of an R/C input filter without creating large offsets due to input bias current. Figure 5 shows proper implementation of this input filter to preserve the INA121’s excellent high frequency common-mode rejection. Mismatch of the common-mode input time constant (R_1C_1 and R_2C_2), either from stray capacitance or mismatched values, causes a high frequency common-mode signal to be converted to a differential signal. This degrades common-mode rejection. The differential input capacitor, C_3 , reduces the bandwidth and mitigates the effects of mismatch in C_1 and C_2 . Make C_3 much larger than C_1 and C_2 . If properly matched, C_1 and C_2 also improve ac CMR.

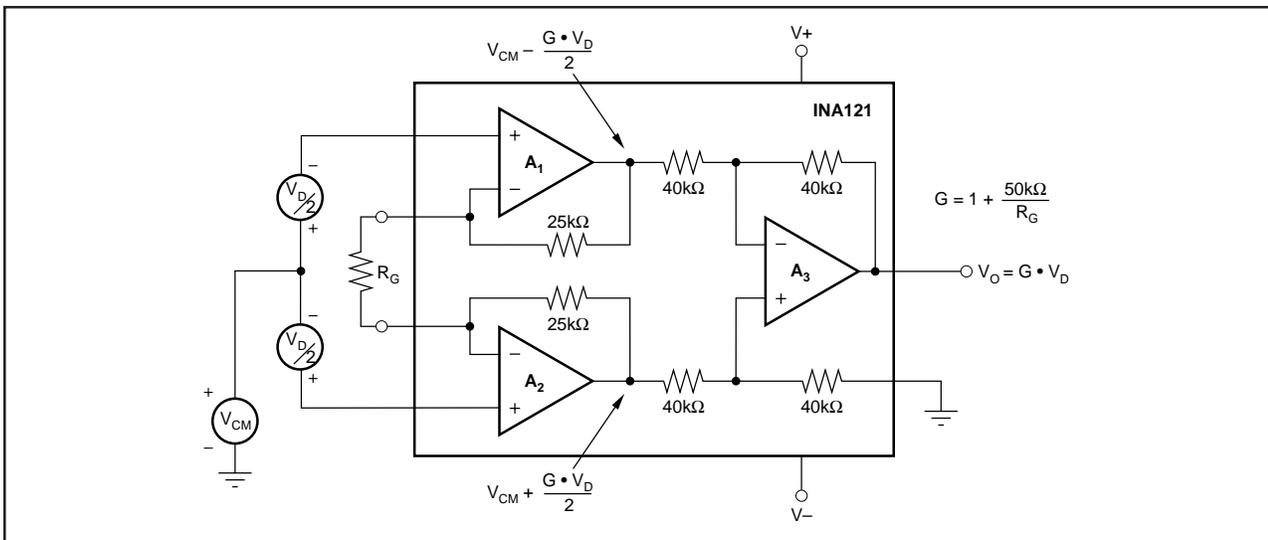


FIGURE 4. Voltage Swing of A_1 and A_2 .

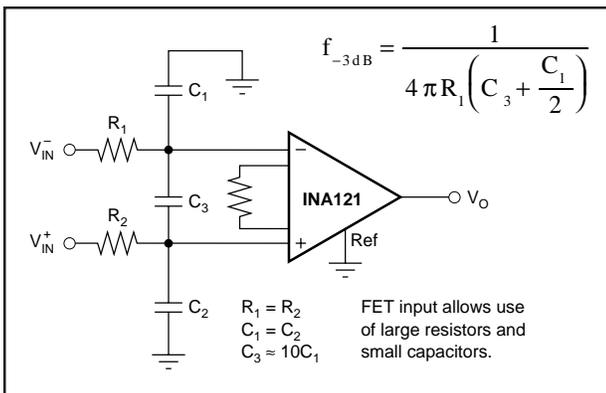


FIGURE 5. Input Low-Pass Filter.

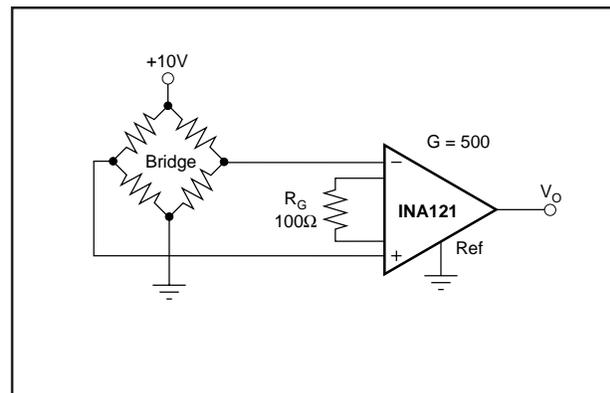


FIGURE 6. Bridge Transducer Amplifier.

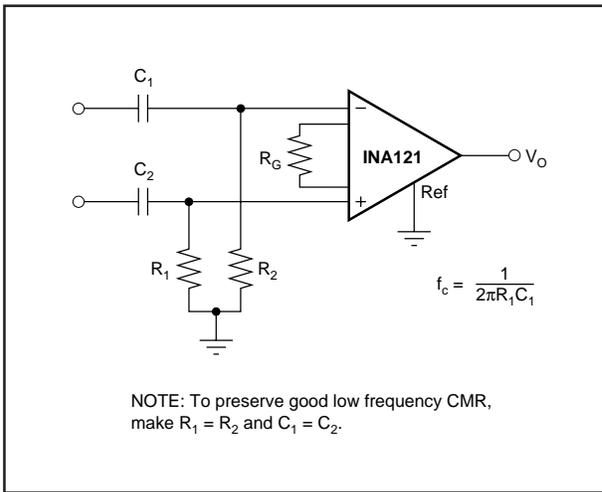


FIGURE 7. High-Pass Input Filter.

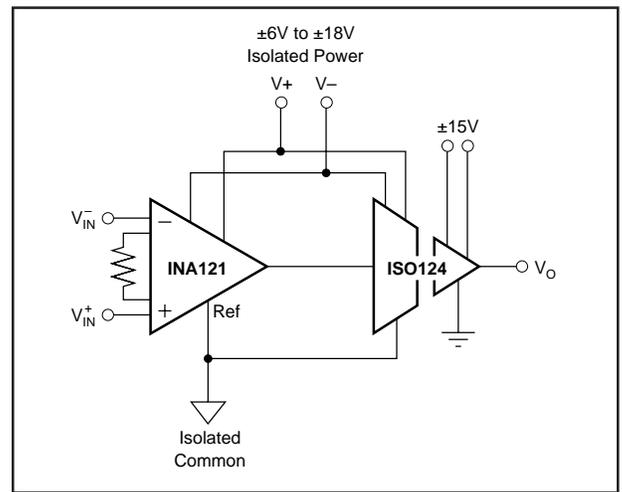


FIGURE 8. Galvanically Isolated Instrumentation Amplifier.

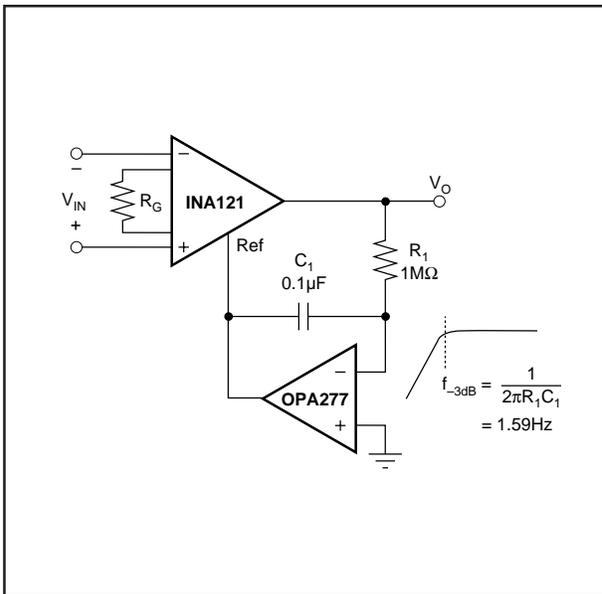


FIGURE 9. AC-Coupled Instrumentation Amplifier.

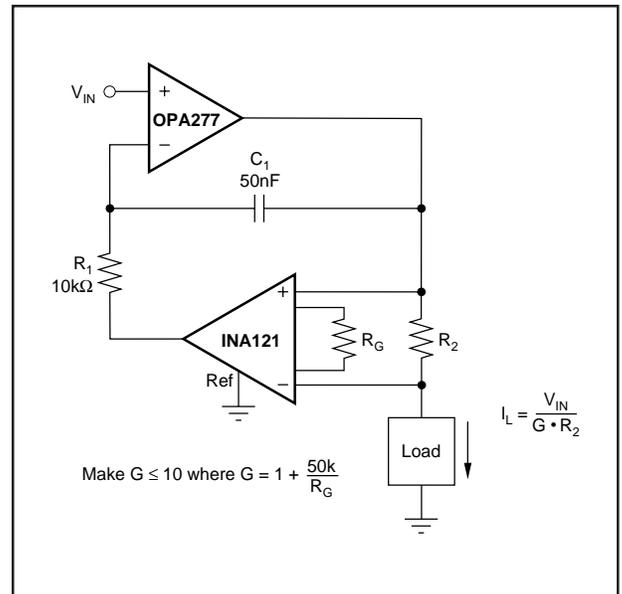


FIGURE 10. Voltage Controlled Current Source.

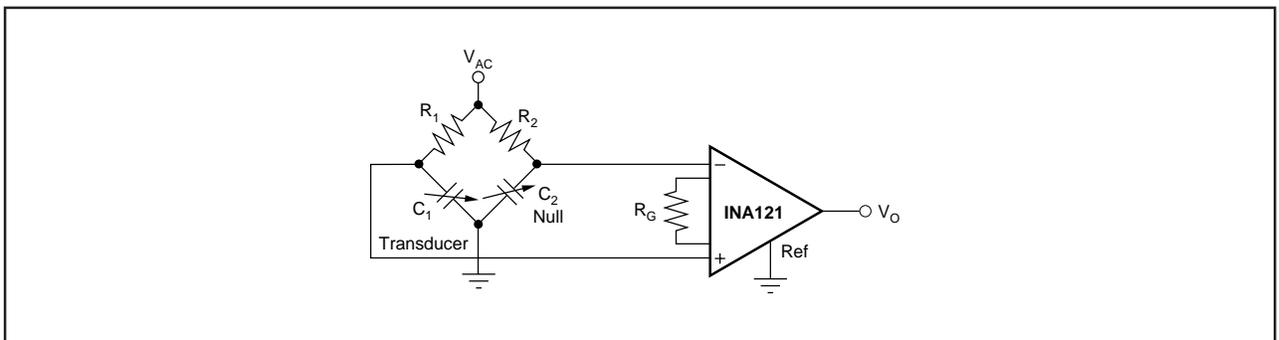


FIGURE 11. Capacitive Bridge Transducer Circuit.

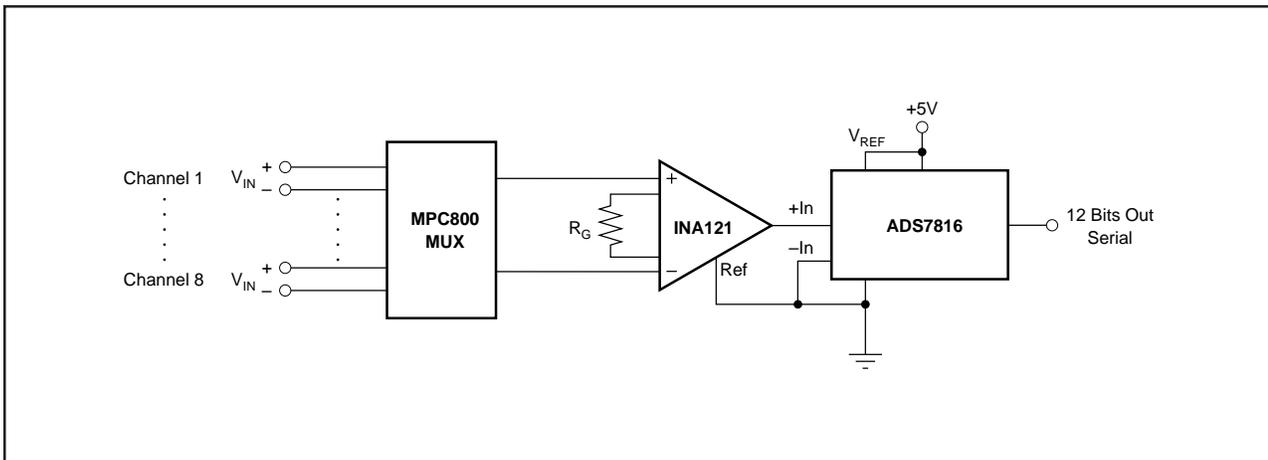


FIGURE 12. Multiplexed-Input Data Acquisition System.

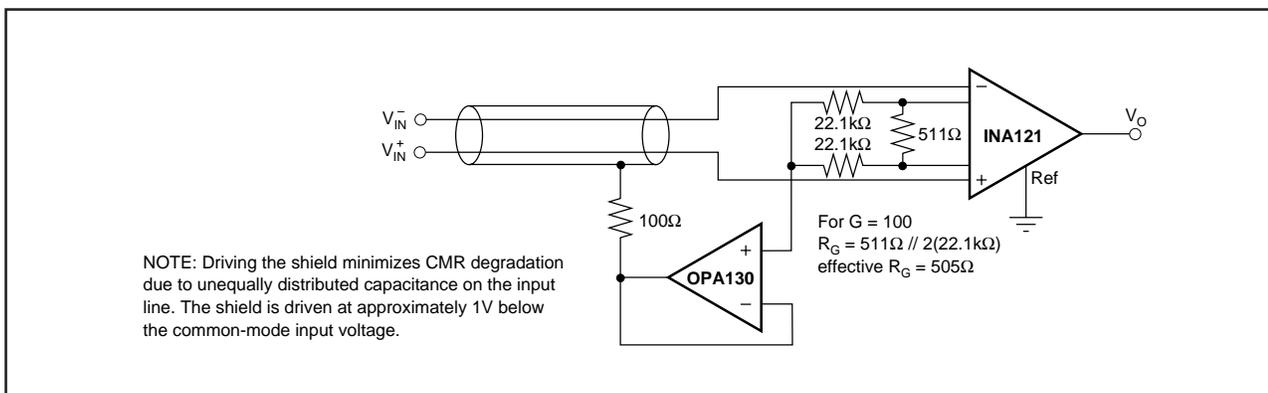


FIGURE 13. Shield Driver Circuit.

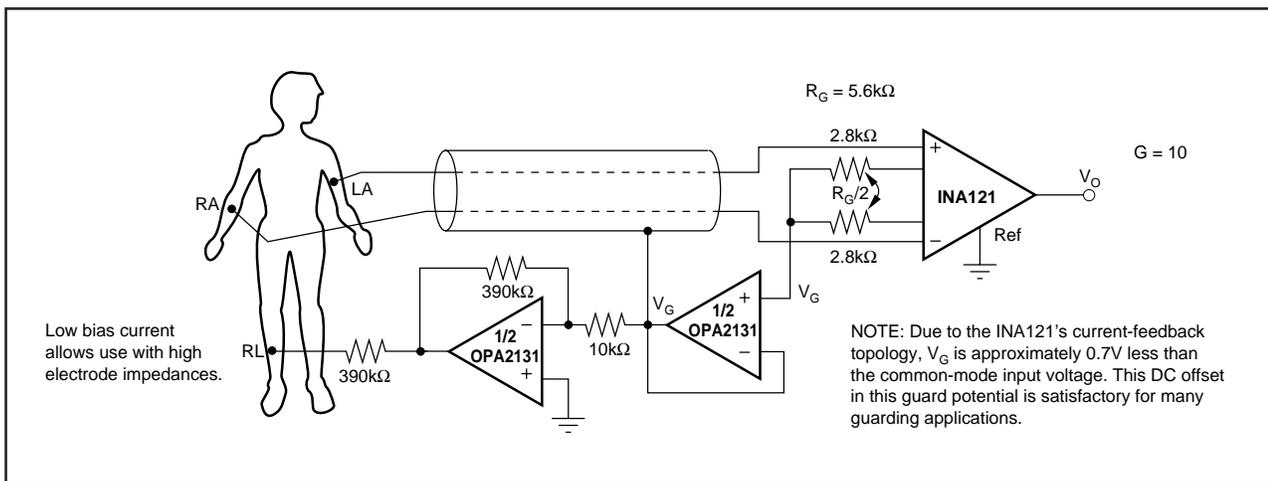


FIGURE 14. ECG Amplifier With Right-Leg Drive.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| INA121P | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | N / A for Pkg Type | -40 to 85 | INA121P A | Samples |
| INA121PA | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | N / A for Pkg Type | | INA121P A | Samples |
| INA121PAG4 | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | N / A for Pkg Type | | INA121P A | Samples |
| INA121PG4 | ACTIVE | PDIP | P | 8 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | N / A for Pkg Type | -40 to 85 | INA121P A | Samples |
| INA121U | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U | Samples |
| INA121U/2K5 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U | Samples |
| INA121U/2K5G4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U | Samples |
| INA121UA | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U A | Samples |
| INA121UA/2K5 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U A | Samples |
| INA121UA/2K5E4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U A | Samples |
| INA121UAE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U A | Samples |
| INA121UG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | | INA 121U | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

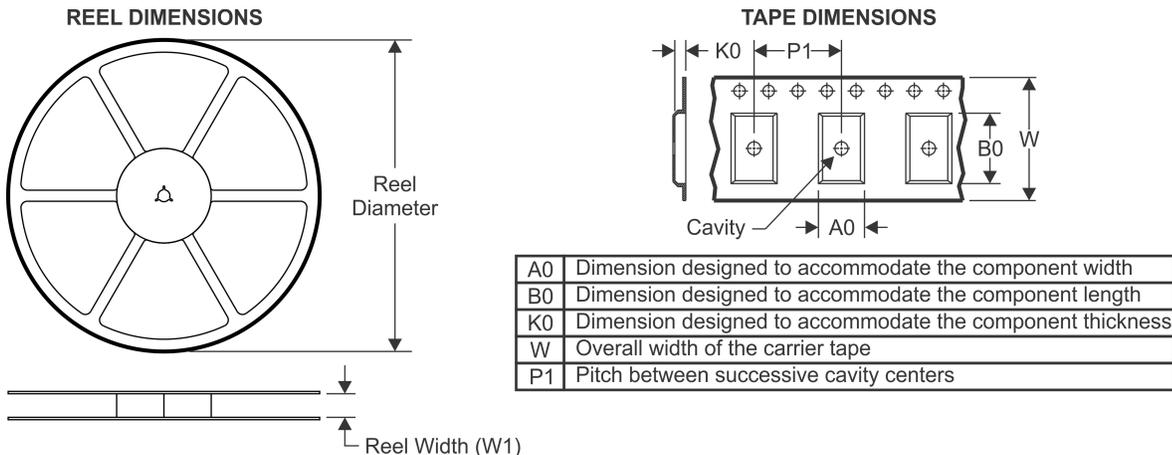
⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

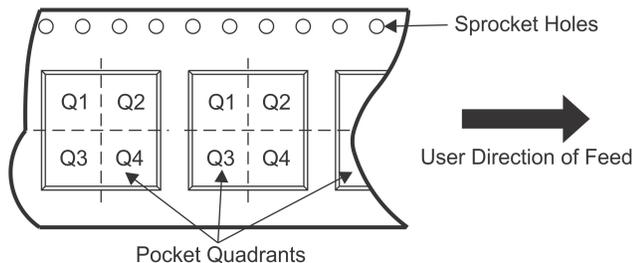
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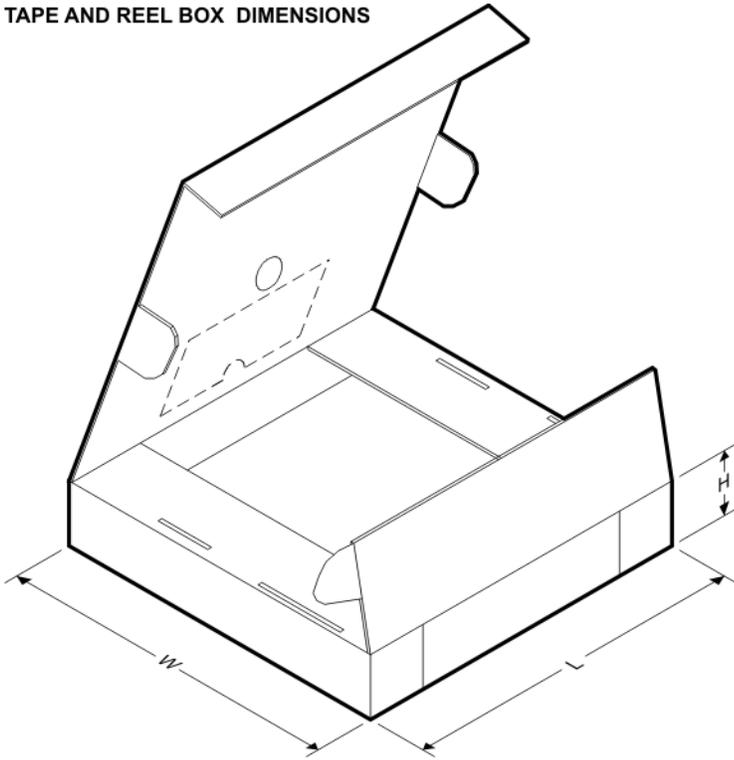


QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| INA121U/2K5 | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| INA121UA/2K5 | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |

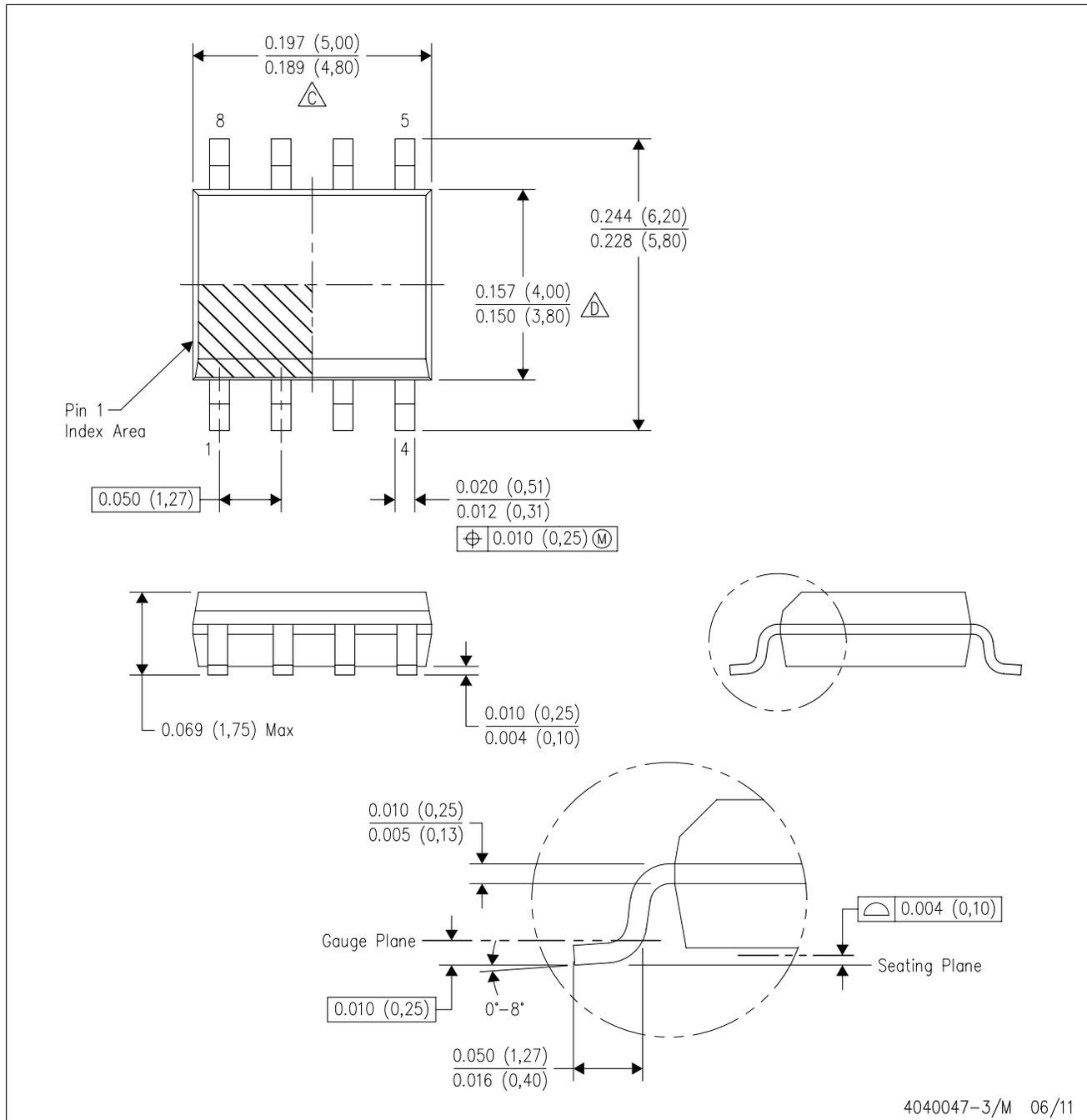
TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| INA121U/2K5 | SOIC | D | 8 | 2500 | 367.0 | 367.0 | 35.0 |
| INA121UA/2K5 | SOIC | D | 8 | 2500 | 367.0 | 367.0 | 35.0 |

D (R-PDSO-G8)

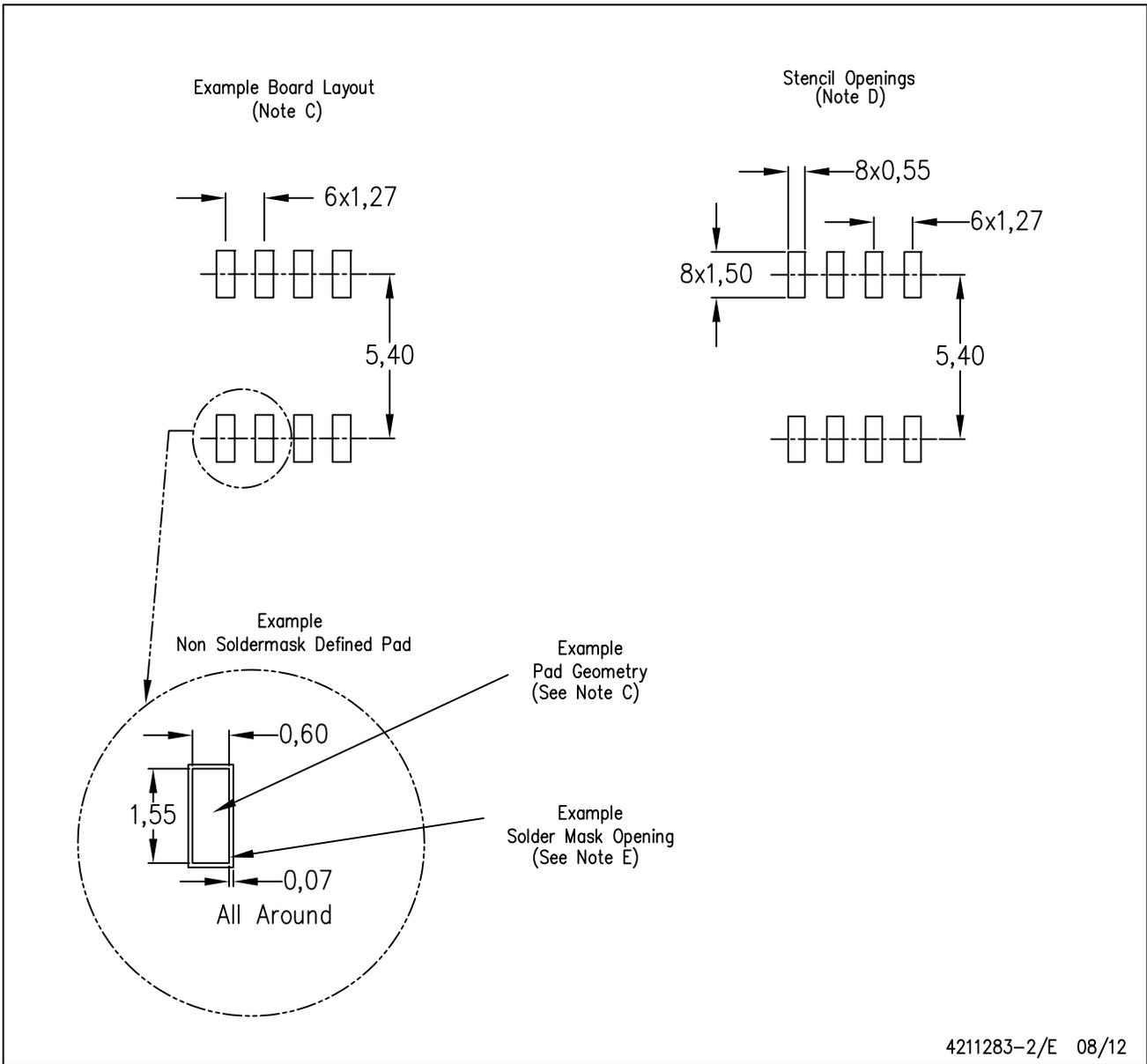
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - $\triangle D$ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

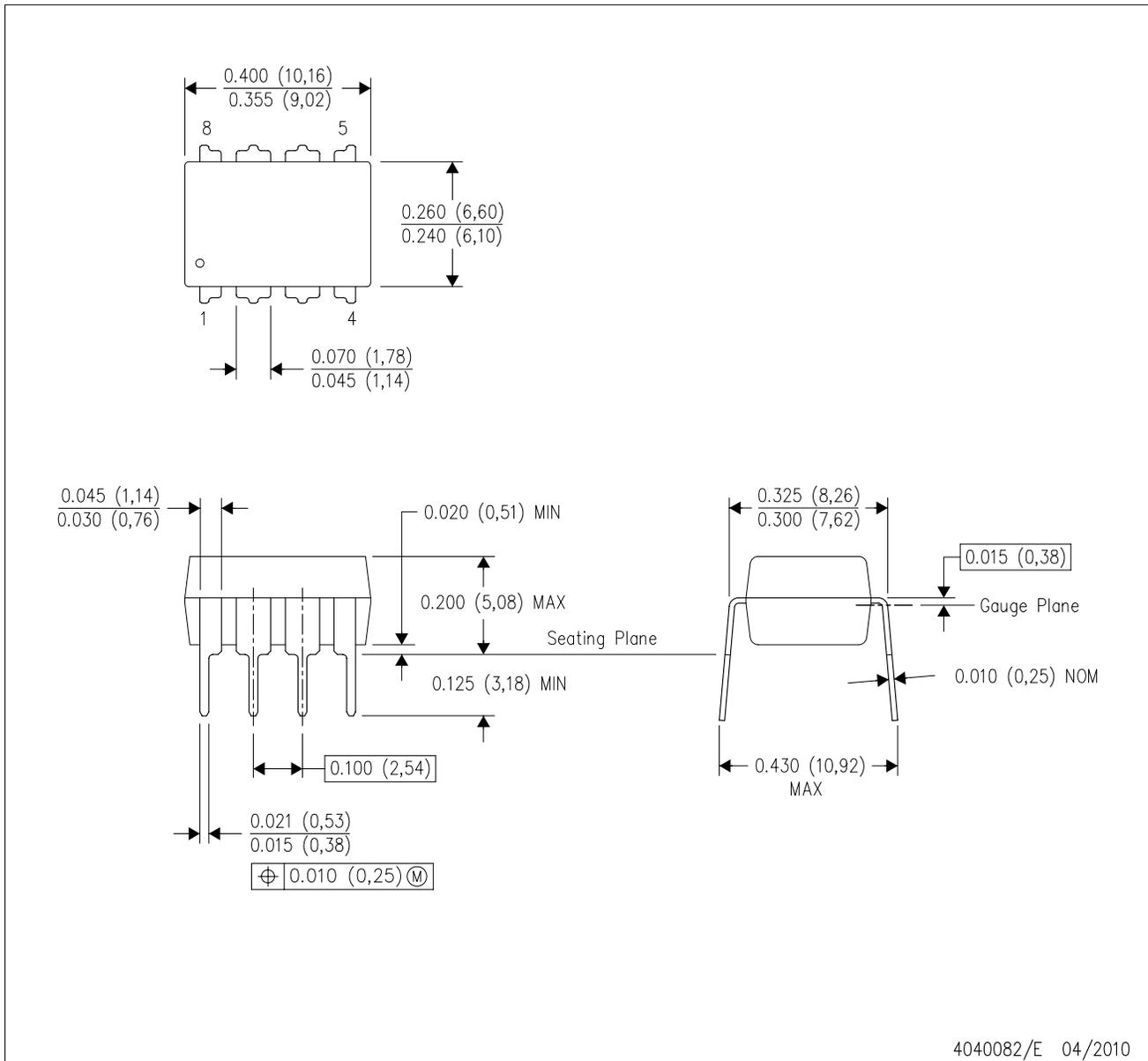
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

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